FAIRCHILD

SEMICONDUCTOR TM

FQD4P25 / FQU4P25 250V P-Channel MOSFET

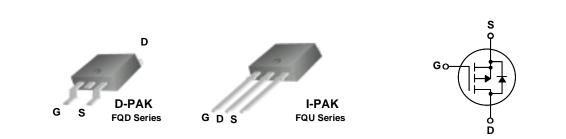
General Description

These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for high efficiency switching DC/DC converters.

Features

- -3.1A, -250V, $R_{DS(on)} = 2.1\Omega @V_{GS} = -10 V$ Low gate charge (typical 10 nC)
- Low Crss (typical 10.3 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQD4P25 / FQU4P25	Units	
V _{DSS}	Drain-Source Voltage		-250	V	
I _D	Drain Current - Continuous (T _C = 25	°C)	-3.1	Α	
	- Continuous (T _C = 100°C)		-1.96	A	
I _{DM}	Drain Current - Pulsed	(Note 1)	-12.4	Α	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	280	mJ	
I _{AR}	Avalanche Current	(Note 1)	-3.1	Α	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	4.5	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-5.5	V/ns	
PD	Power Dissipation ($T_A = 25^{\circ}C$) *		2.5	W	
	Power Dissipation ($T_C = 25^{\circ}C$)		45	W	
	- Derate above 25°C	T	0.36	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

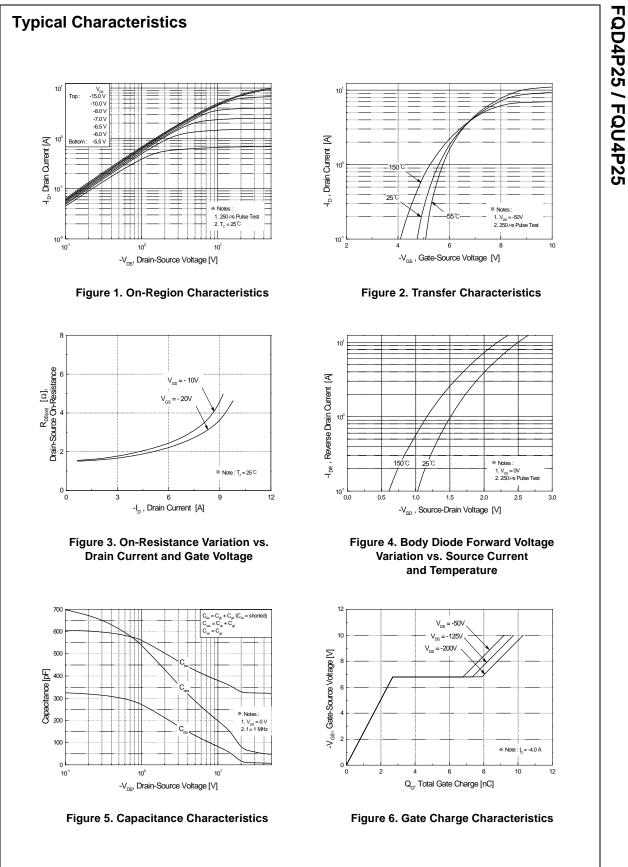
Symbol	Parameter	Тур	Max	Units	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case		2.78	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient *		50	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W	

©2000 Fairchild Semiconductor International

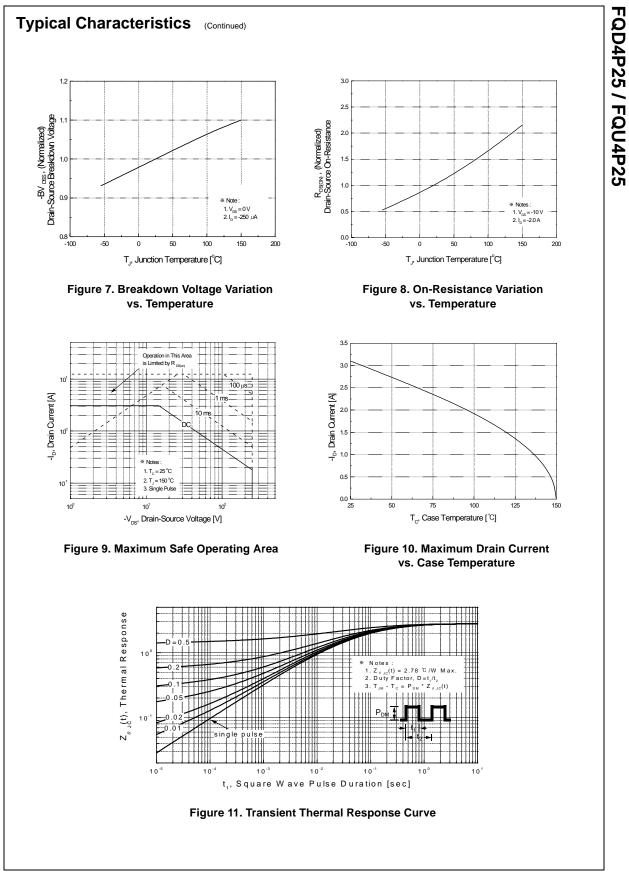
December 2000

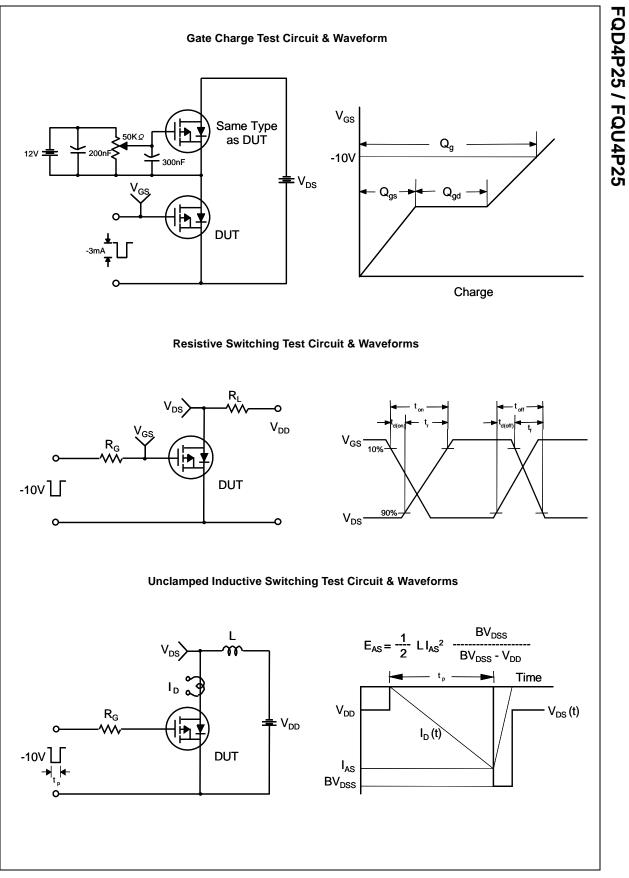
ТМ

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-250			V
∆BV _{DSS} ∆T _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-0.21		V/°C
DSS		$V_{DS} = -250 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA
	Zero Gate Voltage Drain Current	V _{DS} = -200 V, T _C = 125°C			-10	μA
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Cha	racteristics					
/ _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-3.0		-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -1.55 A		1.63	2.1	Ω
FS	Forward Transconductance	$V_{DS} = -40 \text{ V}, I_D = -1.55 \text{ A}$ (Note 4)		2.0		S
	ic Characteristics					
liss	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$		325	420	pF
Coss Crss	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		65 10	85 13	pF pF
Switchi	ng Characteristics Turn-On Delay Time	V _{DD} = -125 V, I _D = -4.0 A,		9.5	30	ns
r	Turn-On Rise Time	$R_{\rm G} = 25 \Omega$		60	130	ns
d(off)	Turn-Off Delay Time			14	40	ns
f	Turn-Off Fall Time	(Note 4, 5)		27	65	ns
ζ ^g	Total Gate Charge	V _{DS} = -200 V, I _D = -4.0 A,		10.3	14	nC
ک _{gs}	Gate-Source Charge	V _{GS} = -10 V		2.7		nC
λ ^{gd}	Gate-Drain Charge	(Note 4, 5)		5.2		nC
Drain-S	ource Diode Characteristics a	nd Maximum Ratings				
S	Maximum Continuous Drain-Source Did				-3.1	Α
SM	Maximum Pulsed Drain-Source Diode F	Forward Current			-12.4	Α
/ _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -3.1 A			-5.0	V
r	Reverse Recovery Time	V _{GS} = 0 V, I _S = -4.0 A,		140		ns
ל ^{ער}	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$ (Note 4)		0.64		μC
L = 46.6mH, _{SD} ≤ -4.0A, Pulse Test :	ating : Pulse width limited by maximum junction tempe $I_{AS} = -3.1A$, $V_{DD} = -50V$, $R_G = 25 \Omega$, Starting $T_J = 25^{\circ}$ di/dt $\leq 300A/\mu$ s, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}$ C Pulse width $\leq 300\mu$ s, Duty cycle $\leq 2\%$ ndependent of operating temperature					

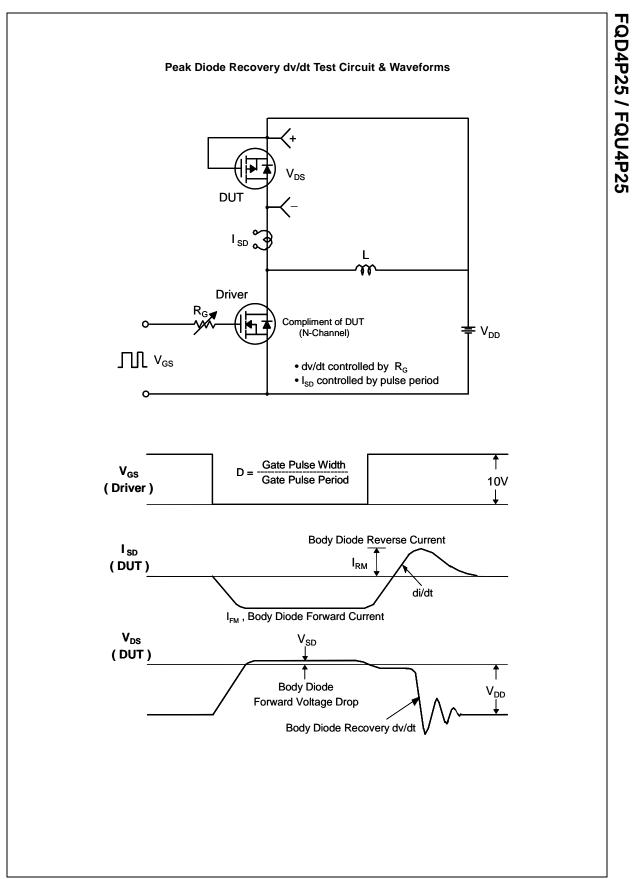


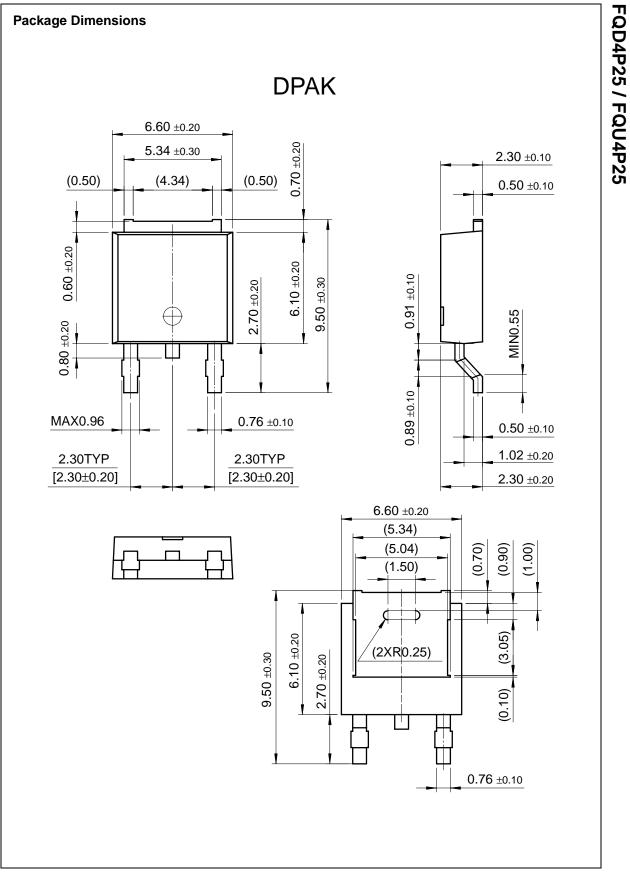
Rev. A2, December 2000

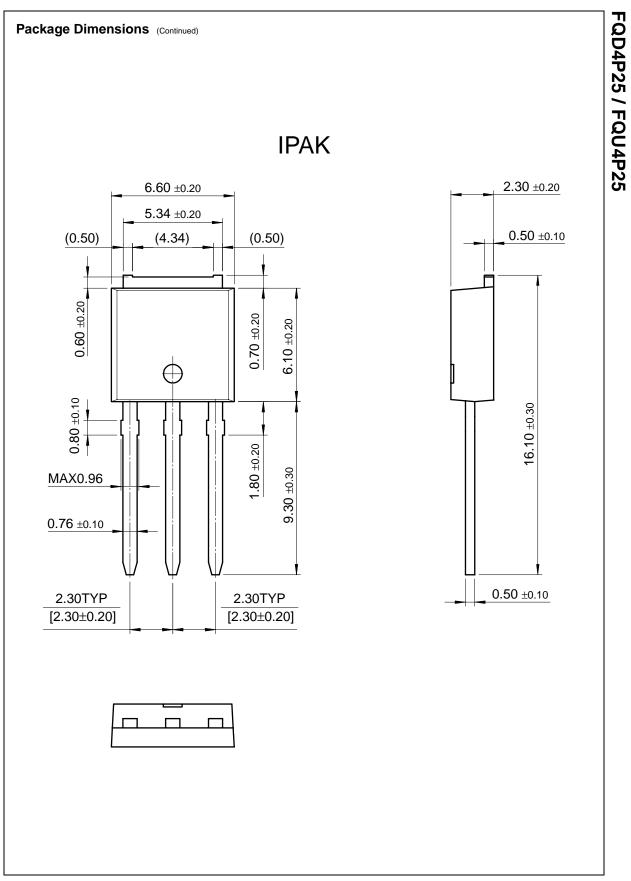




Rev. A2, December 2000







Rev. A2, December 2000

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACExTM BottomlessTM CoolFETTM CROSSVOLTTM E^2 CMOSTM FACTTM FACT Quiet SeriesTM FAST[®] FAST[®] FASTrTM GTOTM HiSeC[™] ISOPLANAR[™] MICROWIRE[™] POP[™] PowerTrench[®] QFET[™] QS[™] Quiet Series[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8 SyncFET[™] TinyLogic[™] UHC[™] VCX[™]

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR INTERNATIONAL.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to

result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Fairchild Semiconductor	sSEARCH Parametric Cross Reference			
		space	Product Folders and Applica	
find products	Home >> Find products >>			
Products groups Analog and Mixed Signal Discrete Interface Logic Microcontrollers Non-Volatile Memory Optoelectronics Markets and applications New products	FQU4P25 250V P-Channel QFET Contents <u>General description Features Product</u> <u>status/pricing/packaging</u> General description These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS	Datasheet <u>Download this</u> <u>datasheet</u> PDF <u>e-mail this datashe</u> [E- This page Print version	Distributor and field sales representatives Dotted line Quality and reliability	
Product selection and parametric search Cross-reference search technical information	technology. This advanced technology is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well		Dotted line Design tools	
buy products technical support	suited for high efficiency switching DC/DC - converters.	-		
my Fairchild company	back to top Features			

- -3.1A, -250V, $R_{DS(on)} = 2.1\Omega @V_{GS} = -10V$
- Low gate charge (typical 10nC)
- Low Crss (typical 10.3pF)
- Fast switching
- 100% avalanche tested

back to top

Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Packing method
FQU4P25TU	Full Production	\$0.474	TO-251(IPAK)	3	RAIL

* 1,000 piece Budgetary Pricing

back to top

<u>Home</u> | <u>Find products</u> | <u>Technical information</u> | <u>Buy products</u> | <u>Support</u> | <u>Company</u> | <u>Contact us</u> | <u>Site index</u> | <u>Privacy policy</u>

© Copyright 2002 Fairchild Semiconductor